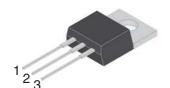
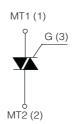
COMPLIANT



STANDARD TRIAC

TO-220AB





On-State Current

Gate Trigger Current

25 Amp

 \leq 100 mA

Off-State Voltage

200 V ÷ 800 V

FEATURES

- Glass/passivated die junctions
- High current Triac
- Low thermal resistance
- High surge current capability
- Low forward voltage drop
- Solder dip 260°C, 10s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC
- Meets MSL level 3, per J-STD-020, LF maximum peak of 260° C

MECHANICAL DATA

- Case: TO-220AB. Epoxy meets UL 94V-0 flammability rating.
- Polarity: As marked on the body.
- **Terminals:** Matte tin plated leads, solderable per MIL-STD-750 Method 2026, J-STD-002 and JESD22-B102. Consumer grade, meets JESD 201 class 1A whisker test.

TYPICAL APPLICATIONS

Suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits... or for phase control operation in light dimmers, motor speed controllers.

Maximun Ratings and Electrical Characteristics at 25°C

SYMBOL	PARAMETER	CONDITIONS	Value	Unit
I _{T(RMS)}	RMS On-state Current (full sine wave)	All Conduction Angle, T _c = 100 °C	25	А
I _{TSM}	Non-repetitive On-State Current	Full Cycle, 60 Hz (t = 16.7 ms)	215	А
I _{TSM}	Non-repetitive On-State Current	Full Cycle, 50 Hz (t = 20 ms)	200	А
I ² t	Fusing Current	tp = 10 ms, Half Cycle	313	A ² s
I _{GM}	Peak Gate Current	20 μs max. Tj = 125 °C	4	А
P _{G(AV)}	Average Gate Power Dissipation	Tj = 125 °C	1	W
dI/dt	Critical rate of rise of on-state current	$I_G = 2x I_{GT}, t_r \le 100 \text{ns}$	50	A/µs
		f = 120 Hz, T _j = 125 °C		
T _j	Operating Temperature		(-40 +125)	°C
T _{stg}	Storage Temperature		(-40 +150)	°C
T _{sld}	Soldering Temperature	10s max	260	°C

SYMBOL	PARAMETER		Unit				
OTWIBOL		В	D	М	S	N	Offic
V_{DRM}/V_{RRM}	Repetitive Peak Off State Voltage	200	400	600	700	800	V

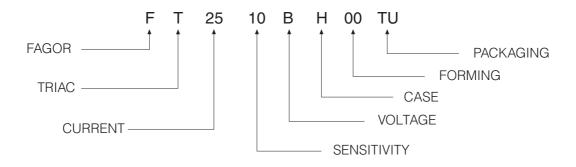


Electrical Characteristics at Tamb = 25 °C

SYMBOL	PARAMETER	CONDITIONS		Quadrant		SENSITIVITY				Unit
OTWIDOL	IAIIAIVILILII	OONDITIO	NO	Quadiant		10	13	18	17	Offic
I _{GT} ⁽¹⁾	Gate Trigger Current	$V_D = 12 V_{DC}, R_L = 330$	$T_j = 25 ^{\circ}\text{C}$	Q1÷Q3	MAX	25	50	25	50	mA
				Q4	MAX	25	75	50	100	mA
V _{GT}	Gate Trigger Voltage	$V_D = 12 V_{DC}, R_L = 330$	$T_{j} = 25 ^{\circ}\text{C}$	Q1÷Q4	MAX		1	.3		V
V_{GD}	Gate Non Trigger Voltage	$V_D = V_{DRM}, R_L = 3.3 \text{ K}\Omega$	$D_{i}, T_{j} = 125 ^{\circ}C$	Q1÷Q4	MIN		0	.2		V
I _H ⁽²⁾	Holding Current	I _T =100 mA,Gate open	n, $T_j = 25$ °C		MAX	25	50	25	50	mA
IL	Latching Current	$I_G = 1.2 I_{GT}, T_j = 25 ^{\circ}C$		Q1,Q3,Q4	MAX	40	70	40	70	mA
				Q2	MAX	60	80	80	100	mA
dV/dt (2)	Critical Rate of Voltage Rise	$V_D = 0.67 \times V_{DRM}$, Gat	e open		MIN	500	650	650	500	V/µs
		T _j = 125 °C								
(dV/dt)c (2)	Critical Rise Rate of Commu-	(dI/dt)c = 13.3 A/ms	$T_j = 125 ^{\circ}\text{C}$		MIN	3	8	5	10	V/µs
	tating off-state voltage									
V _{TM} ⁽²⁾	On-state Voltage	$I_T = 35 \text{ Amp, tp} = 380$	μ s, $T_j = 25$ °C		MAX		1.	55		V
V _{t (0)} (2)	Threshold Voltage	T _j = 125 °C			MAX		0.	85		V
r _d ⁽²⁾	Dynamic resistance	T _j = 125 °C			MAX		1	6		mΩ
I _{DRM} /I _{RRM}	Off-State Leakage Current	$V_D = V_{DRM}$,	T _j = 125 °C		MAX		4	2		mA
		$V_R = V_{RRM}$	$T_j = 25 ^{\circ}C$		MAX		į	5		μΑ
R _{th(j-c)}	Thermal Resistance	for AC 360° conduction	on angle				1	.0		°C/W
	Junction-Case									
R _{th(j-a)}	Thermal Resistance						6	60		°C/W
	Junction-Ambient									

⁽¹⁾ Minimum I_{GT} is guaranted at 5% of I_{GT} max.

Part Number Information



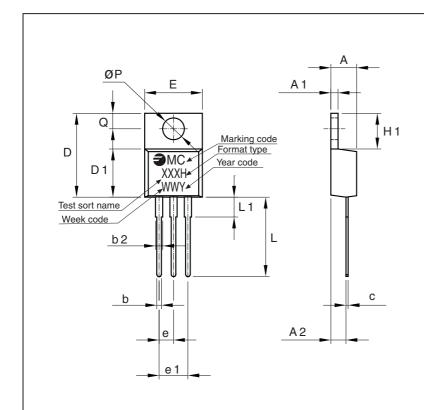
⁽²⁾ For either polarity of electrode MT2 voltage with reference to electrode MT1.



Ordering information

PREFERRED P/N	PACKAGE CODE	DELIVERY MODE	BASE QUANTITY	UNIT WEIGHT (g)
FT2518MH 00TU	TU	TUBE	1000	2.30

Package Outline Dimensions: (mm) TO-220AB



	DIMENSIONS				
REF.	Milimeters				
	Min.	Max.			
А	4.47	4.67			
A1	1.17	1.37			
A2	2.52	2.82			
b	0.71	0.91			
b2	1.17	1.37			
С	0.31	0.53			
D	14.65	15.35			
D1	8.50	8.90			
Е	10.01	10.36			
е	2.51	2.57			
e1	4.98	5.18			
H1	6.15	6.45			
L	13.40	13.96			
L1	3.56	3.96			
Р	3.735	3.935			
Q	2.59	2.89			

Mounting Torque 0.5 N.m



Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 1: Maximum power dissipation versus RMS on-state current (full cycle)

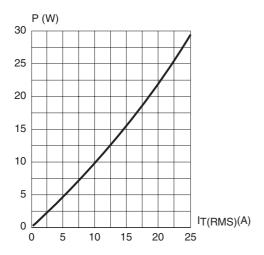


Fig. 3: Relative variation of thermal impedance versus pulse duration.

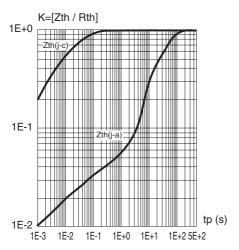


Fig. 5: Surge peak on-state current versus number of cycles

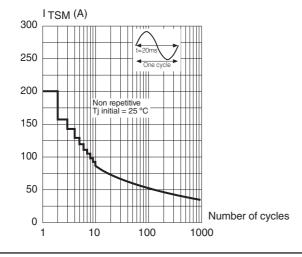


Fig. 2: RMS on-state current versus case temperature (full cycle).

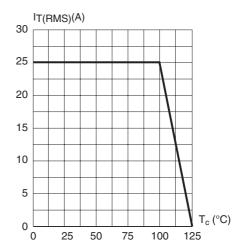


Fig. 4: On-state characteristics (maximum values)

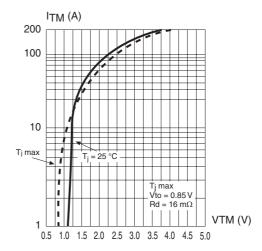
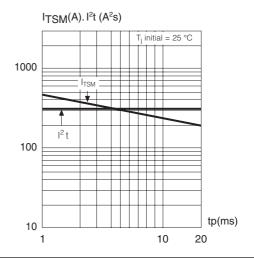


Fig. 6: Non repetitive surge peak on-state current for a sinusoidal pulse with width: tp < 20 ms, and corresponding value of I²t.





Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 7: Relative variation of gate trigger current, holding current and latching versus junction temperature (typical values)

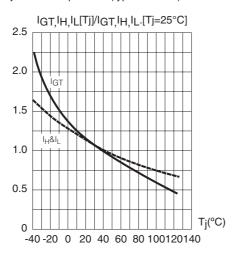


Fig. 9: Relative variation of critical rate of decrease of main current versus

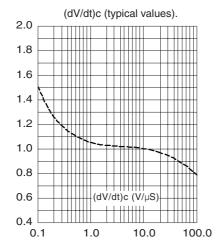
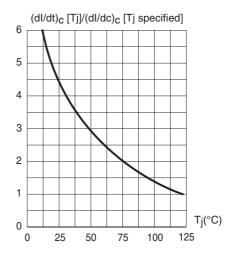


Fig. 8: Relative variation of critical rate of decrease of main current versus junction temperature





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